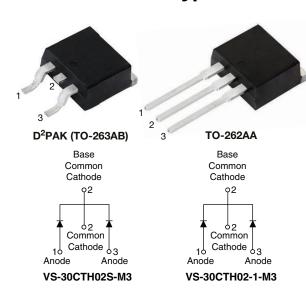


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Vishay Semiconductors

## Hyperfast Rectifier, 30 A FRED Pt®



PRIMARY CHARACTERISTICS								
I <sub>F(AV)</sub>	2 x 15 A							
$V_R$	200 V							
V <sub>F</sub> at I <sub>F</sub>	0.78 V							
t <sub>rr</sub> typ.	30 ns							
T <sub>J</sub> max.	175 °C							
Package	D <sup>2</sup> PAK (TO-263AB), TO-262AA							
Circuit configuration	Common cathode							

#### **FEATURES**

- Hyperfast recovery time
- Low forward voltage drop
- Low leakage current

• 175 °C operating junction temperature



- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **DESCRIPTION / APPLICATIONS**

Vishay Semiconductors 200 V series are the state of the art hyperfast recovery rectifiers designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control, guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, UPS, DC/DC converters as well as freewheeling diode in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS									
PARAMETER		SYMBOL	TEST CONDITIONS	MAX.	UNITS				
Peak repetitive reverse voltage		$V_{RRM}$		200	V				
Average rectified forward current	per diode	I <sub>F(AV)</sub>	T <sub>C</sub> = 159 °C	15					
	per device			30	Α				
Non-repetitive peak surge current	I <sub>FSM</sub>	T <sub>C</sub> = 25 °C	200						
Operating junction and storage ten	$T_J, T_{Stg}$		-65 to +175	°C					

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CONDITIONS	TYP.	MAX.	UNITS					
Breakdown voltage, blocking voltage	$V_{BR}, V_{R}$	I <sub>R</sub> = 100 μA	200	-	-	V				
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 15 A	-	0.92	1.05	V				
		I <sub>F</sub> = 15 A, T <sub>J</sub> = 125 °C	-	0.78	0.85	V				
Devenue le alca es accoment	,	$V_R = V_R$ rated	-	-	10					
Reverse leakage current	I <sub>R</sub>	$T_J = 125 ^{\circ}\text{C},  V_R = V_R  \text{rated}$	-	5	300	μΑ				
Junction capacitance C <sub>T</sub>		$V_{R} = 200 \text{ V}$	-	57	-	pF				
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body	-	8	-	nΗ				

# VS-30CTH02S-M3, VS-30CTH02-1-M3

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<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>C</sub> = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS		
		$I_F = 1 A, dI_F/dt = 5$	-	-	35				
Reverse recovery time	t <sub>rr</sub>	$I_F = 1 A, dI_F/dt = 1$	-	-	30				
		T <sub>J</sub> = 25 °C		-	26	-	ns		
		T <sub>J</sub> = 125 °C	I <sub>F</sub> = 15 A	-	40	-			
Dools woods on a commont	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C	dl <sub>F</sub> /dt = 200 A/μs V <sub>R</sub> = 160 V	-	2.8	-	^		
Peak recovery current		T <sub>J</sub> = 125 °C		-	6.0	-	Α		
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	37	-	nC		
		T <sub>J</sub> = 125 °C		-	120	-	110		

THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS				
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>	-65	-	175	°C				
Thermal resistance, junction to case per diode	R <sub>thJC</sub>	-	-	1.1	°C/W				
Weight		-	2.0	-	g				
Weight		-	0.07	-	OZ.				
Mounting torque		6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)				
Marking daving		Case style D <sup>2</sup> PA	AK (TO-263AB)	30CTH02S					
Marking device		Case style TO-2	262	30CTH02-1					

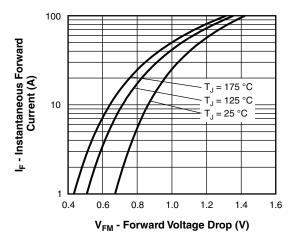


Fig. 1 - Maximum Forward Voltage Drop Characteristics

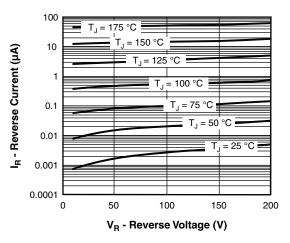


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

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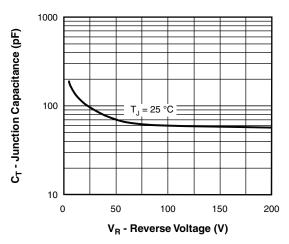


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

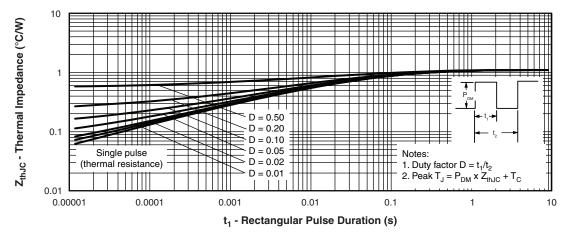


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

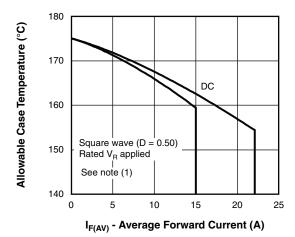


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

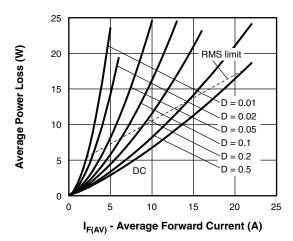


Fig. 6 - Forward Power Loss Characteristics

## VS-30CTH02S-M3, VS-30CTH02-1-M3

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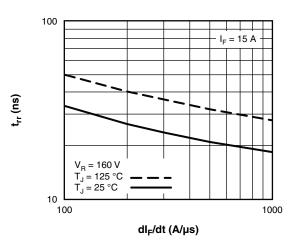


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

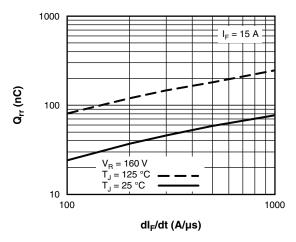
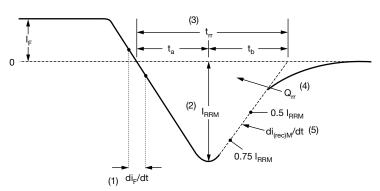


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

#### Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}; \\ Pd = \text{forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}; \\ Pd_{REV} = \text{inverse power loss} = V_{R1} \times I_R \text{ (1 - D); } I_R \text{ at } V_{R1} = \text{rated } V_R \\ \end{array}$ 



- di<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- (3)  $\rm t_{rr}$  reverse recovery time measured from zero crossing point of negative going  $\rm l_F$  to point where a line passing through 0.75  $\rm l_{RRM}$  and 0.50  $\rm l_{RRM}$  extrapolated to zero current.
- (4)  $Q_{rr}$  area under curve defined by  $t_{rr}$  and  $I_{RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) di<sub>(rec)M</sub>/dt - peak rate of change of current during t<sub>b</sub> portion of t<sub>rr</sub>

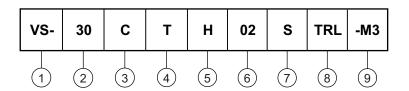
Fig. 9 - Reverse Recovery Waveform and Definitions

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### **ORDERING INFORMATION TABLE**

Device code



Vishay Semiconductors product

2 - Current rating (30 A)

3 - C = common cathode

T = TO-220, D<sup>2</sup>PAK (TO-263AB)

5 - H = hyperfast rectifier

6 - Voltage rating (02 = 200 V)

- • S =  $D^2$ PAK (TO-263AB)

• -1 = TO-262AA

None = tube (50 pieces)

• TRL = tape and reel (left oriented, for D<sup>2</sup>PAK (TO-263AB) package)

• TRR = tape and reel (right oriented, for D<sup>2</sup>PAK (TO-263AB) package)

9 - Environmental digit:

-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)									
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION							
VS-30CTH02S-M3	50	Antistatic plastic tubes							
VS-30CTH02STRL-M3	800	13" diameter plastic tape and reel							
VS-30CTH02STRR-M3	800	13" diameter plastic tape and reel							
VS-30CTH02-1-M3	50	Antistatic plastic tubes							

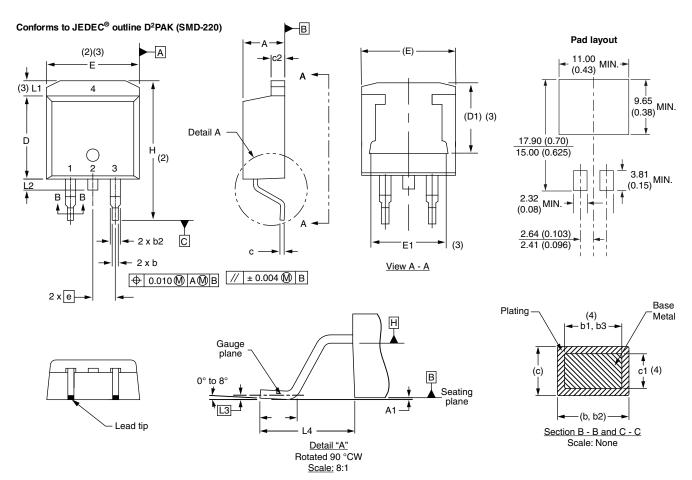
LINKS TO RELATED DOCUMENTS							
Dimensions	D <sup>2</sup> PAK (TO-263AB)	www.vishay.com/doc?96164					
Dimensions	TO-262AA	www.vishay.com/doc?96165					
Part marking information	D <sup>2</sup> PAK (TO-263AB)	www.vishay.com/doc?95444					
	TO-262AA	www.vishay.com/doc?95443					
Packaging information		www.vishay.com/doc?96424					



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## D<sup>2</sup>PAK

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INC	INCHES		NOTES	SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	STWBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54 BSC 0.100 BSC		BSC		
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inches
- (7) Outline conforms to JEDEC® outline TO-263AB

Revision: 13-Jul-17 Document Number: 96164



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